ISL78264EVAL1Z

User's Manual: Evaluation Board

Automotive

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User's Manual

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Evaluation Board

The ISL78264EVAL1Z board demonstrates the two-channel synchronous buck converter operation of the <u>ISL78264</u> in which the converters have 180 phase shift to minimize input capacitor stress. It illustrates the high efficiency of synchronous buck operation and all the features of the IC including overcurrent protection, overvoltage and undervoltage protection, and power-good indication for each channel.

Key Features

- V_{IN} operating range: 3.75V to 42V
- Selectable Forced PWM or ECM Mode with Iq = 6µA (one channel)
- Programmable switching frequency: 200kHz to 2.2MHz
- Dropout mode for high duty-cycle operation
- · 20ns on-times for low duty-cycle operation
- External synchronization
- Programmable spread spectrum clocking
- 180° phase shift between channels
- 2A Sourcing/3A sinking MOSFET drivers
- Boot UVLO and programmable boot refresh time
- Extensive protection mechanisms for OV/UV/OC/OT
- · Monitor test points for key signals

Specifications

This board is configured and optimized for the following operating conditions. See <u>"Operating Range" on page 4</u> for more detailed descriptions.

- VIN_TYP = 12-14V
- VIN_MAX = 42V (typical)
- VOUT1 = 5V (up to 10A)
- VOUT2 = 3.3V (up to 10A)
- f_{SW} = 2.2MHz

Ordering Information

Part Number	Description
ISL78264EVAL1Z	ISL78264 evaluation board

Related Literature

For a full list of related documents, visit our website:

ISL78264 device page





Figure 1. ISL78264EVAL1Z Block Diagram



1. Functional Description

The ISL78264EVAL1Z evaluation board photos are shown in <u>Figures 2</u> and <u>3</u>. The board supports a quick evaluation of various features of the ISL78264 while demonstrating a power solution providing two rail voltages with very high efficiency over a wide load range. The ISL78264EVAL1Z demonstrates the feature set of the ISL78264 supporting automotive applications powered from a car battery.

1.1 Recommended Equipment

- VBAT (V_{IN} supply): 50V power supply with 20A source current capability
- Output Loads: Two loads capable of >10A
- · Digital Multimeters (DMM) and/or oscilloscope to monitor various voltages

1.2 Operating Range

- Enable operation
 - \circ S1 and S2 control EN1 and EN2 for Converter 1 and Converter 2, respectively.
 - \circ EN1 has a 100k Ω resistor to VIN to allow auto-start of Channel 1 when VIN is applied.
 - \circ EN2 has a 10k Ω pull-up resistor to VCC, requiring V_{CC} to be present for Channel 2 to be enabled.
 - $\circ\,$ The converters are allowed to start when the input voltage (V_IN), rises above 5.65V (typical).
- VIN_MIN = 6V or lower
 - $\circ\,$ The board shuts down when V_{CC} falls below 4V (typical)
- VIN_TYP = 12V
- VIN_MAX = 42V (typical)
- IOUT_MAX = 10A
- f_{SW} = 2.2MHz as selected with R16 = 6.81k Ω
- The board is set in ECM mode by default with J10 (FCCM) open, which allows R46 (100kΩ) to pull the SYNC pin low.
- The board is set to connect 5V output of Channel 1 to EXTSUP (U1-20) with a jumper shorting Pins 2-3 of J15 to provide an efficient 5V source for control and gate drive power
- Switches S3 and S4 allow setting the operating configurations as detailed in the datasheet
 - \circ S3 should have position 8 **ON** to connect VSEL (U1-3) to R31 (75k Ω) to ground to select Converter 1 as 5V fixed voltage
 - \circ S3 should have position 3 **ON** to connect VSEL (U1-1) to R26 (54.9k Ω) to ground to select Boot refresh time of 300ns
 - $\circ\,$ S4 should have position 3 **ON** to connect VSEL (U1-3) to R34 (14.7k Ω) to ground to select minimum dead time and Spread Spectrum **OFF**

1.3 External Connections and Setup Before Start-Up

- 1. Connect the V_{IN} power supply between VBAT (J1) and GND (J2). Before typical start-up, set the V_{IN} power supply voltage to 12V. The power supply output should remain off before start-up.
- 2. For initial startup position S1 and S2 in **OFF** position.
- 3. Connect separate electronic loads between VOUT1 (J6) and GND (J5), and VOUT2 (J3) and GND (J4). Set the electronic load to 0A for the first start-up. The load should remain off before start-up.
- 4. Place the DMMs or oscilloscope appropriately where the signals are to be measured.
- 5. Switch S1 to **ON** position to enable VOUT1.
- 6. Switch S2 to **ON** position to enable VOUT2.

2. PCB Layout Guidelines

2.1 ISL78264EVAL1Z Evaluation Board



Figure 2. ISL78264EVAL1Z Evaluation Board (Top)



Figure 3. ISL78264EVAL1Z Evaluation Board (Bottom)



2.2 ISL7202xCSEHEVAL1Z Circuit Schematic



Figure 4. Schematic - Page 1 of 2

ISL78264EVAL1Z







Figure 5. Schematic - Page 2 of 2

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Connector/ Test Point	Signal Name	Description
J1	VBAT	VIN supply connection for positive input.
J2	GND	VIN supply GND connection.
J3	VOUT2	VOUT2 connection to load.
J4	GND	VOUT2 GND connection to load.
J5	GND	VOUT1 GND connection to load.
J6	VOUT1	VOUT1 connection to load.
J10	FCCM	Jumper open to allow ECM operation; install to force FCCM.
J11	LOWIQ2	Jumper normally installed for PGOOD2; open to measure low I _Q .
J12	LOWIQ1	Jumper normally installed for PGOOD1; open to measure low I _Q .
J13	PG2PU	Jumper normally installed for PGOOD2; open to measure low I _Q .
J14	PG1PU	Jumper normally installed for PGOOD1; open to measure low I _Q .
J15	BST_ON/CH1_BIAS	Jumper normally connects VOUT1 to EXTSUP1.
J16	CNT	Jumper installed to connect S4 and CNT configuration resistor.
J17	5VBST	Jumper normally open; can be used to connect U2-2 to EXTSUP1.
J18	VSEL	Jumper installed to connect S3 and VSEL configuration resistor.
J19	ALT_5V_SUP	Jumper normally open; can be installed to use alternate bias supply.
TP1	PGD2	Test point to monitor PGOOD2 on pin U1-32.
TP2	CNT2	Test point to monitor CNT2 on pin U1-14.
TP3	EN2	Test point to monitor EN2 on pin U1-4.
TP4	COMP1	Test point to monitor COMP1 on pin U1-6.
TP5	COMP2	Test point to monitor COMP2 on pin U1-7.
TP6	ISEN2P	Test point to monitor ISEN2P on pin U1-28.
TP7	ISEN2N	Test point to monitor ISEN2N on pin U1-27.
TP8	HS2	Test point to monitor HS2 on pin U1-24.
TP10	GND	
TP11	VCC	Test point to monitor V _{CC} .
TP13	RT	Test point to monitor RT on pin U1-8.
TP14	BOOT2	Test point to monitor BOOT2 on pin U1-25.
TP15	LX2	Test point to monitor BOOT2 on pin U1-23.
TP16	LS2	Test point to monitor LS2 on pin U1-22.
TP17	VCC	Test point to monitor Vcc on pin U1-19.
TP18	EXTSUP	Test point to monitor EXTSUP on pin U1-20.
TP19	FB2	Test point to monitor FB2 on pin U1-5.
TP20	ISEN1P	Test point to monitor ISEN1P on pin U1-10.
TP21	ISEN1N	Test point to monitor ISEN1N on pin U1-9.
TP22	CNT	Test point to monitor CNT on pin U1-14.
TP23	PGD1	Test point to monitor PGOOD1 on pin U1-12.
TP24	BOOT1	Test point to monitor BOOT1 on pin U1-15.
TP25	HS1	Test point to monitor HS1 on pin U1-16.
TP26	LX1	Test point to monitor LX1 on pin U1-19.
TP27	LS1	Test point to monitor LS1 on pin U1-18



Table 1. Connector/Monitor Pin Descriptions (Continued)

Connector/ Test Point	Signal Name	Description
TP28	VBAT	Test point to monitor VBAT supply voltage.
TP29	VOUT2	Test point to monitor VOUT2 voltage.
TP30	FB1	Test point to monitor FB1 on pin U1-2.
TP32	VOUT1	Test point to monitor VOUT1 voltage.
TP10, TP33, TP34, TP35, TP36, TP38, TP42, TP45, TP48	GND	Test point to connect to GND.
TP37	SYNC	Test point to monitor SYNC pin U1-13.
TP39	EN1	Test point to monitor EN1 pin U1-29.
TP40	INJ1	Test point to inject signal for Channel 1 control loop evaluation.
TP41	INJ2	Test point to inject signal for Channel 2 control loop evaluation.
TP43	U2_SW	Test point to monitor voltage on pin U2-8.
TP44	U2_SUP	Test point to monitor voltage on pin U2-7.
TP46	ALT_5V_SUP	Test point to monitor voltage on J19-2.

2.3 Bill of Materials

Reference Designator	Description	Manufacturer	Manufacturer Part
	PWB-PCB, ISL78264EVAL1Z, REVC, ROHS	Imagineering	ISL78264EVAL1ZREVCPCB
C34	CAP, SMD, 0603, 1.0µF, 16V, 10%, X7R, ROHS	TDK	C1608X7R1C105K
C3, C8, C21, C25, C38, C43	CAP-AEC-Q200, SMD, 0805, 0.1µF, 100V, 10%, X7R, ROHS	ТDК	CGA4J2X7R2A104K125AA
C14, C16, C41, C44	CAP-AEC-Q200, SMD, 2220, 4.7µF, 100V, 10%, X7R, ROHS	TDK	CGA9N2X7R2A475K230KA
C10, C11, C12, C22, C23, C24, C35, C37, C46, C48	CAP-AEC-Q200, SMD, 2220, 47µF, 16V, 20%, X7R, ROHS	ТDК	CGA9N3X7R1C476M230KB
C6, C26, C42	CAP-AEC-Q200, SMD, 0805, 10µF, 10V, 10%, X7R, ROHS	Murata	GCJ21BR71A106KE01L
C13, C20	CAP-AEC-Q200, SMD, 0603, 4700pF, 100V, 10%, X7R, ROHS	Murata	GCM188R72A472KA37D
C15, C45	CAP, SMD, 0603, 10pF, 50V, 10%, NP0, ROHS	Venkel	C0603COG500-100KDE
C29, C30	CAP, SMD, 0603, 10µF, 16V, 10%, X5R, ROHS	Murata	GRM188R61C106KAALD
C18, C40	CAP, SMD, 0603, 2200pF, 100V, 10%, X7R, ROHS	Venkel	C0603X7R101-222KNE
C17, C39	CAP, SMD, 0603, DNP-PLACE HOLDER, ROHS		
C7, C19,	CAP, SMD, 0805, 0.22µF, 100V, 10%, X7R, ROHS	Kemet	C0805C224K1RACAUTO
L1, L2	COIL-PWR INDUCTOR, SMD, 10.9x10, 0, 1μH, 20A, 20%, 2.65mΩ, ROHS	Wurth Elektronik	7443330100
C1, C2	CAP-AEC-Q200, SMD, 10.3mm, 120μF, 50V, 20%, 28mΩ, ROHS	Panasonic	EEH-ZC1H121P
L3	COIL-INDUCTOR, SMD, 1210, 2.2μH, 30%, 1.85A, 76.8mΩ, WW, ROHS	Murata	LQH32PN2R2NNCL
TP45, TP46	CONN-TURRET, TERMINAL POST, TH, ROHS	Keystone	1514-2
TP1-TP8, TP10, TP11, TP13-TP44, TP48	CONN-MINI TEST POINT, VERTICAL, WHITE, ROHS	Keystone	5002
J1, J2, J3, J4, J5, J6	CONN-JACK, MINI BANANA, 0.175 PLUG, NICKEL/BRASS, ROHS	Keystone	575-4
J10, J11, J12, J13, J14, J17, J19	CONN-HEADER, 1x2, BRKAWY 1x36, 2.54mm, ROHS	BERG/FCI	68000-236HLF



Reference Designator	Description	Manufacturer	Manufacturer Part
J15, J16, J18	CONN-HEADER, 1x3, BREAKAWY 1x36, 2.54mm, ROHS	BERG/FCI	68000-236HLF
J11, J12, J13, J14, J15- Pins 2-3, J16-Pins 1-2, J18-Pins 2-3	CONN-JUMPER, SHORTING, 2PIN, BLACK, GOLD, ROHS	Sullins	SPC02SYAN
D1, D2	DIODE-SCHOTTKY, SMD, 2P, SOD123W, 60V, 1A, Vf = 530mV at 1A, ROHS	Nexperia	PMEG6010ER, 115
D7, D8	DIODE-SCHOTTKY, SMD, TO-277A(SMPC), 100V, 12A, ROHS	Vishay	V12P10-M3/86A
LED1, LED2	LED, SMD, 1206, GREEN, 75mW, 3mcd, 567nm, ROHS	Dialight	597-3311-407NF
U2	IC-SYNCRONOUS BOOST CONVERTER, 8P, DFN, ROHS	Renesas	ISL78113AARAZ
U1	IC-DUAL BUCK CONTROLLER, 32P, WFQFN, 5x5, ROHS	Renesas	ISL78264ARZ
Q1, Q2	TRANSISTOR, N-CHANNEL, 3LD, SOT-23, 60V, 115mA, ROHS	Diodes, Inc.	2N7002-7-F
Q3-Q10	TRANSISTOR-MOS, N-CHANNEL, SMD, 4P, LFPAK, 40V, 33A, 18.1mΩ, ROHS	NXP	BUK9Y21-40E, 115
R20, R63	RES-AEC-Q200, SMD, 0603, 6.04Ω, 1/10W, 1%, TF, ROHS	Vishay/Dale	CRCW06036R04FKEA
R56	RES-AEC-Q200, SMD, 0603, 0.1Ω, 1/4W, 1%, TF, CURR.SENSE, ROHS	Panasonic	ERJ-3BSFR10V
R8, R11, R54	RES, SMD, 0603, 1Ω, 1/10W, 1%, TF, ROHS	Panasonic	ERJ-3RQF1R0V
R51, R70	RES, SMD, 0603, 4.7Ω, 1/10W, 1%, TF, ROHS	Venkel	CR0603-10W-4R70FT
R7, R10, R21, R23, R32, R40, R43, R44, R47, R48, R49, R59	RES, SMD, 0603, 0Ω, 1/10W, TF, ROHS	Venkel	CR0603-10W-000T
R19, R65, R67, R68	RES, SMD, 0603, 10k, 1/10W, 1%, TF, ROHS	Venkel	CR0603-10W-1002FT
R12, R39, R41, R42, R46	RES, SMD, 0603, 100k, 1/10W, 1%, TF, ROHS	Venkel	CR0603-10W-1003FT
R25, R34	RES, SMD, 0603, 14.7k, 1/10W, 1%, TF, ROHS	Venkel	CR0603-10W-1472FT
R9	RES, SMD, 0603, 150k, 1/10W, 1%, TF, ROHS	Yageo	RC0603FR-07150KL
R60	RES, SMD, 0603, 24.3k, 1/10W, 1%, TF, ROHS	Yageo	RC0603FR-0724K3L
R35	RES, SMD, 0603, 24.9k, 1/10W, 1%, TF, ROHS	Panasonic	ERJ-3EKF2492V
R30, R36	RES, SMD, 0603, 37.4k, 1/10W, 1%, TF, ROHS	Yageo	RC0603FR-0737K4L
R26, R37	RES, SMD, 0603, 54.9k, 1/10W, 1%, TF, ROHS	Panasonic	ERJ-3EKF5492V
R24, R29, R33	RES, SMD, 0603, 6.04k, 1/10W, 1%, TF, ROHS	Venkel	CR0603-10W-6041FT
R16	RES, SMD, 0603, 6.81k, 1/10W, 1%, TF, ROHS	Yageo	RC0603FR-076K81L
R27, R31, R38, R61	RES, SMD, 0603, 75k, 1/10W, 1%, TF, ROHS	Venkel	CR0603-10W-7502FT
R15	RES, SMD, 0603, 787k, 1/10W, 1%, TF, ROHS	Yageo	RC0603FR-07787KL
R57	RES, SMD, 0603, 8.25kΩm, 1/10W, 1%, TF, ROHS	Panasonic	ERJ-3EKF8251V
R13, R14, R17, R50, R53, R55, R58, R62, R64, R66, R69	RES, SMD, 0603, DNP-PLACE HOLDER, ROHS		
R1, R2	RES, SMD, 0805, 750Ω, 1/8W, 1%, TF, ROHS	Panasonic	ERJ-6ENF7500V
R3, R28	RES, SMD, 1210, DNP, DNP, DNP, TF, ROHS		
R4, R5	RES-AEC-Q200, SMD, 2512, 0.005Ω, 2W, 1%, CURR.SENSE, MF, ROHS	Vishay/Dale	WSL25125L000FEA18
S3, S4	SWITCH-SLIDE DIP, SMD, 8POS, SPST, 100mA, 12V, SEALED, ROHS	CTS Electronic Components	219-8MSTR
S1, S2	SWITCH-TOGGLE, SMD, 6PIN, SPDT, 2POS, ON-NONE-ON, ROHS	ITT Industries /C&K Division	GT11MSCBE



2.4 Board Layout



Figure 6. Silkscreen Top



Figure 7. Layer 1



Figure 8. Layer 2



Figure 9. Layer 3





Figure 10. Layer 4



Figure 11. Layer 5



Figure 12. Layer 6



Figure 13. Silkscreen Bottom



3. Typical Performance Curves



Figure 14. Buck 1/2 Start-Up with V_{IN} Rising



Figure 15. Steady State ECM Operation with IOUT1 = 0.5A



Figure 16. Buck 1 Efficiency VOUT1 = 5V



Figure 17. Buck 2 Efficiency VOUT2 = 3.3V



4. Revision History

Rev.	Date	Description
1.00	Jul.24.20	Initial release



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